WORLDWIDE ASSEMBLY & TEST FACILITY DATABASE, 2021 EDITION

SERVICES — TECHNOLOGIES — APPLICATIONS

The *Worldwide Assembly & Test Facility Database* is a comprehensive report tracking over 475 total back-end facilities of IDMs and outsourced semiconductor assembly and testing manufacturers in China, Taiwan, Korea, Japan, Southeast Asia, Europe, and the Americas. This report is an essential business tool for anyone interested to learn more about the semiconductor back-end supply chain.

Details include:

- Plant site technology capability: Tape and Reel, Test
- Packaging assembly service offered: BGA, specific leadframe type such as QFP, QFN, SO, flip chip bumping, WLP, Modules/SIP, etc.
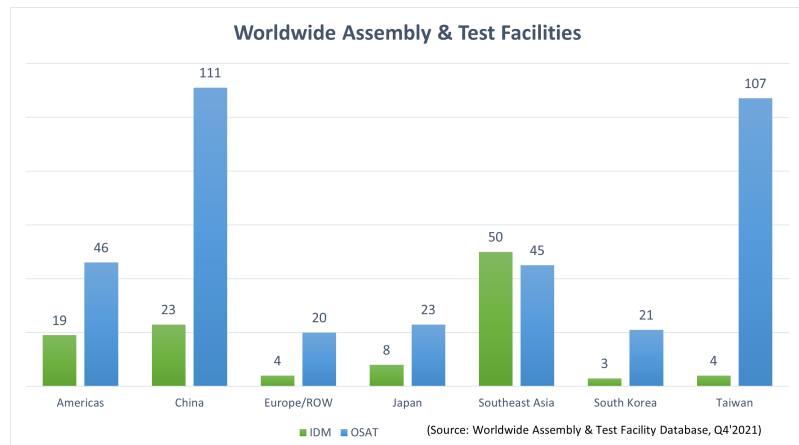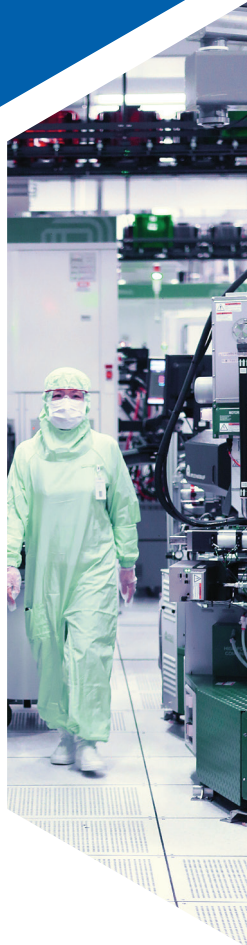- Plant site specialization: TSV, RF, Cu Pillar, RDL, etc.

FEATURES

- More than 200 companies and more than 475 total back-end facilities
- Over 110 OSAT facilities in China, over 100 in Taiwan, over 45 in Americas
- Over 50 IDM A&T facilities in Southeast Asia, around 25 in China, and around 20 in Americas

BENEFITS

- Gain insight to worldwide IDM assembly/test and OSAT facilities capabilities and expertise.
- Understand key packaging capabilities and technologies by IDM and OSAT.
- Identify new business opportunities and assess competition.

TO REQUEST A SAMPLE:

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Worldwide Assembly & Test Facilities

Region	IDM	OSAT
Americas	19	46
China	23	111
Europe/ROW	4	20
Japan	8	23
Southeast Asia	50	45
South Korea	3	21
Taiwan	4	107

(Source: Worldwide Assembly & Test Facility Database, Q4'2021)

2022 PRICING INFORMATION - ONE TIME PURCHASE

	SEMI MEMBER	NON-MEMBER
1 user	$7,000	$9,250
2-3 users	$13,500	$17,750
4+ users - Corporate License	$27,000	$35,500

HOW TO ORDER: https://www.semi.org/en/products-services/purchase-market-reports
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